The ATLAS RPC Phase II ugrade for High Luminosity LHC era

PAOLO CAMARRI (UNIVERSITY OF ROMA «TOR VERGATA» AND INFN ROMA TOR VERGATA

ON BEHALF OF THE ATLAS MUON COMMUNITY

XVII Conference on Resistive Plate Chambers and Related Detectors Santiago de Compostela (Spain), 9-13 September 2024



The High-Luminosity LHC

LHC / HL-LHC Plan





2

The ATLAS RPC upgrade for Phase II

The HL-LHC luminosity increase $(7.5 \cdot 10^{34} \text{ cm}^{-2} \text{ s}^{-1} \text{ at } \sqrt{s} = 14 \text{ TeV } pp$, average number of interactions per bunch crossing $\langle \mu \rangle = 200$) foresees a major upgrade for the ATLAS Muon Trigger system. About 300 new-generation RPC triplets will be inserted in the Barrel Inner region (BI), and the old on-detector trigger boards will be replaced with new ones

- Improved trigger redundancy (from 6 to 9 layers)
- Increased trigger acceptance (from 78% to 92%, and to 96% by requiring BI-BO coincidence)
- Improved time resolution for time-of-flight measurements: new thin-gap RPCs (1 mm) and new read-out electronics (0.4 ns for BI RPCs, from 2 ns to 1.1 ns for legacy RPCs)
- \circ BI RPC detector surface: 472 m²
- 306 BI RPC triplets
- o 8262 new front-end boards





BI-RPC: gas volumes, singlets and chambers

Gas volume: a gas volume is composed of a gas gap enclosed between two High-Pressure Laminate (HPL) plates. A graphite layer is deposited on the external face of each HPL⁻ plate. Total gas-volume thickness: about 4.5 mm

Singlet: the gas volume is enclosed between two read-out panels with η -oriented strips (parallel to the long side of the chamber), forming a «singlet». The gas volume with the read-out panels is enclosed in a Faraday cage consisting of the outer faces (copper) with their edges connected by conductive copper tape. Singlet thickness: about 13 mm

BI chamber: three singlets (a «triplet») are inserted within a suitable mechanical structure to form a BI chamber. BIL-RPCs will be inserted in the Large sectors, while BIS-RPCs will be inserted in the Small sectors. BI chamber thickness: about 65 mm



New gas volumes

A new design for the gas volumes has been used, with several changes with respect to the ATLAS legacy RPC detectors:

- Gas-gap thickness: reduced from 2 mm to 1 mm
- The gas distribution was re-designed, with 4 inlets for connecting the gas pipes on the corners of the gas volume, drilled in the profile
- New HV-cable connection on the the gas-volume side
- The 6 mm diameter gas pipes were replaced with 3 mm diameter gas pipes
- The graphite-layer resistivity was reduced from 500 kΩ/□ to 320 kΩ/□ and the footprint was redesigned to reduce the risk of
 possible current leaks
- Electrode thickness: reduced from 1.8 mm to 1.4 mm

The production of the gas volumes in Italy has started in 2023 and is expected to end in 2025, carried out by General Tecnica Engineering (GTE).

Two new possible production centers are undergoing a qualification process: Munich (Max Planck Institute, MPI) and Hefei (University of Science and Technology of China, USTC)

(P. Camarri and M. Schioppa's other talk for more details on the QA/QC of BIL RPCs)

Qualification of gas volumes

Tests of HPL plates are carried out by INFN at GTE:

- Measurement of the HPL bulk resistivity (maximum value accepted: $10^{11} \Omega$ cm)
- Sample measurement of plate thickness
- Visual inspection for detecting any possible macroscopic defects

Gas-volume tests are carried out at GTE and CERN:

- 10 tests are carried out by the manufacturer
- 3 tests are carried out by CERN-INFN
 - Current vs Voltage (I-V) characterization (max 1 μ A @ 3.5 kV max 3 μ A @ 6.1 kV after ohmic-current subtraction)
 - Gas-tightness test (Δp < 0.1 mbar after 3 minutes)
 - Current-leak test
- Conditioning at GIF++
 - The I-V curve is measured again with the source off
 - The gas volumes are exposed to γ radiation from a ^{137}Cs source, at approximately 4800 V (max 20 $\mu A/m^2)$



Current vs voltage test of gas volumes

- The BI-RPC gas volumes are in production. In agreement with the tender requirements, gas volumes are accepted if the measured total current is less than 1 μ A at 3.5 kV and a measured current less than 3 μ A at 6.1 kV after subtracting the ohmic component, extrapolated by performing a linear fit in the [0 3] kV range
- All gas volumes must undergo this test before invoicing. The plots below show the total current (left) and the recalculated current after subtracting the ohmic component (right) as a function of the applied voltage, for a whole production batch of BIL gas volumes
- This tested production batch met the acceptance requirements



Gas-volume thermal tests

Stress tests were carried out on 4 BIL-type gas volumes with thermal cycles in the climatic chamber of the ATLAS laboratories at INFN Frascati. Additional tests are performed on BIS-type gas volumes at the Cambridge University.

Several cycles were carried out:

- 5 x [10 °C 30 °C]
- 4 x [0 °C 30 °C]
- 3 x [-10 °C 30 °C]
- 3 x [-20 °C 30 °C]

The gas volumes were flushed in parallel during the thermal cycles with low dew point dry air, applying 1.8 mbar overpressure at the gas inlet:

- 2 temperature sensors were inserted into the gas gaps to evaluate the delay in temperature variation and the attenuation of the cycle range
- •At the end of each cycle, the thermal-equilibrium conditions were verified after 15 minutes
- Mechanical strength and gas tightness were monitored during the thermal cycles





Read-out panels

New read-out panels consisting of 3 layers:

- One layer of 3 mm thick aramid paper honeycomb
- Two layers of 0.4 mm thick copper-plated FR4 on which the read-out strips are made by a photo-engraving process

Panel thickness and materials are chosen to optimize the strip impedance and the detector weight. A termination resistor is soldered to the ends of each strip and guard wire.

The construction of the read-out panels is shared between INFN Cosenza (BIL) and Hefei China (BIS).

INFN Cosenza site capability = 800 panels/year, also carrying out the following tests:

- Thickness measurement of FR4 panels
- Thickness measurement of Aramid paper honeycomb
- Thickness measurement of the assembled panel surface (7 cm x 7 cm matrix)
- Panel length and width + strip-width measurement
- Electrical continuity measurements for strips and guard wires





(see P. Camarri and M. Schioppa's other talk for more details on the production of BIL-RPC read-out panels)

Front-End electronics

For BI-RPCs, an ASIC chip has been developed by INFN Roma Tor Vergata, integrating preamplifier, discriminator and TDC. This new design results in improved stability and sensitivity compared to the BIS-78 FE and also allows the φ -coordinate reconstruction:

- Detectable signal of 1-2 fC
- Minimum discrimination threshold of 0.3 mV
- Voltage-Controlled Oscillator (VCO) defining the TDC time resolution driving the scaler (50-150 ps RMS)
- Data encoded using the Manchester code
- Each ASIC chip has 8 channels, each with its own serial transmission line



(L. Pizzimento's talk for more details on the new FEE)

10 ASIC chips were irradiated with a neutron flux of 10¹³ n_{eq}/cm² at the China Spallation Neutron Source (Dongguan) to check the chip radiation hardness: no change was observed in the discriminator and in the VCO response after the irradiation.



ϕ -coordinate measurement

The BI-RPC detectors have only η -oriented read-out strips, equipped with FE electronics using a TDC with 100 ps time resolution at the opposite ends.

The ϕ -coordinate reconstruction is obtained from the propagation time of the signals on the strips and from the propagation velocity.

- The signal propagation velocity on the strip can be measured by measuring the time difference on the opposite read-out strip ends.
- This measurement has been carried out by placing 2-cm wide trigger scintillators orthogonal to the strip, at different positions.





Layout of the BI-RPC chambers

The design of the BI-RPC mechanics has been defined for all the main chambers (4 BIL types: BIL 680S – BIL 680L – BIL 620S – BIL 520S covering 75% of the BIL sectors; 2 BIS types: BIS1 and BIS from 2 to 6, covering all the BIS sectors involved in the Phase-II upgrade) and other special cases.

In the feet sectors (S11 and S15) new chambers will be installed in the Barrel Outer region: 80 identical BOR-BOM chambers without overlapping, of BIS-like size.



Production chain



Production Database

Infrastructure

- mySQL DB managed via a web interface to keep track of components (gas gaps, HPL plates)
 - Including relationships (i.e. what goes into what)
- Web interface for presenting QA/QC test results (e.g. I-V curves) for the components
- •Based on CERN login, now restricted to the users directly involved in this activity

Status

- Management of panels and gas gaps ready
- Next step: implementation of singlets
- Long-term goal: implementation of triplets and chambers



Factory Acceptance Tests Documents

QUALITY ASSURANCE											
Factory tests on ATLAS RPC Phase-2 gas volumes											
Date:20/11/2023											
Gas gap ID: BIL1A_32/23											
HPL foils employed: <u>147</u> and	215										
1) Graphite coating	X PASSED	NOT PASSED									
2) Absence of scratches	X PASSED	NOT PASSED									
3) Absence of bubbles	X PASSED	NOT PASSED									
4) Glue producer recommendations	X PASSED	NOT PASSED									
5) Envelope dimensions	X PASSED O NOT PASSED										
6) Gas tightness before applying kapton (ΔP after 3 minutes must be < 0.1 mbar)											
∆P after 3 minutes [mbar]:< 0.1	PASSED	NOT PASSED									

7) Mechanical rigidity, with the injection of a volume of air equal to 1% of the gas volume (Δ P after 1 minute must be \ge 2 mbar)

ΔP after 1 minute [mbar]: 2.4 PASSED ONT PASSED

8) Current leakage before applying kapton (using a conductive foam pressed along the edges) with both electrodes at 7 kV ($_{0m}$ must be < 0.2 μ A = 20 mV/10⁶ Ω for BIS and < 0.3 μ A = 30 mV/10⁶ Ω for BIL)

Current 24.4 [mV/10^s Ω] at HV 7 [kV] X PASSED ONOT PASSED

9) Oiling test using mock up gas volume

PASSED NOT PASSED

Further comments

Data Collector and Transmitter (DCT)

The DCT connects the detector FE with the ATLAS Barrel Sector Logic (SL), where trigger logic operations are carried out. Two kinds of DCT are developed:

- BMBO-DCT (Legacy RPC system): receives hit analog pulse from the FE, measures the arrival time with FPGA-TDC and sends time data to the SL.
 - First prototype extensively tested (both HW ans SW):
 - Communication test with SL
 - Read-out test with a BML RPC at INFN Roma Tor Vergata:
 - 0.8 ns time resolution on the cosmic-ray time of flight between two RPCs
 - 0.24 ns TDC time resolution on $\eta\text{-}\phi$ panels facing the same gas volume
 - Second prototype under test: irradiation test completed 1208 BMBO-DCT foreseen to be installed
- BI-DCT (BI-RPC): receives hit time digital data from FE-TDC, decodes and sends «Bunch Crossing ID» tagged time data to SL, reconstructs φ coordinate from time difference of two n-n read-outs
 - Schematics ready, first prototype being submitted
 - FE-DCT communication test ongoing
 - Planned to be tested in the cosmic-ray station at CERN BB5
 338 BI-DCT foreseen to be installed







Cosmic-ray test stand

				8
			Singeista	
			Singel et to5	
			Singolet to4	
			Singelet to 3	
			Singolet to2	
			Singeleitat	
			8013 8	2
				Ĩ.
			80.2 R	
ſ			BIL2	
ç			Bit 1	
<u></u>				
	ينينين	10-10-10-10-10-10-10-10-10-10-10-10-10-1	90L1 R	
	19192	10101	İİ	
	Singlet	trigger sector		
나르미 같은 도	Cingici		니마	
	Triplet	trigger sector		



Two trigger sectors available for QA/QC test:

- Upper sector to certify up to 6 BIL singlets
- Lower sector to certify up to 2 BIL chambers (triplets)

Tower structure with 4 RPC Legacy detectors used as trigger

- 1 at the top
- 2 in the middle
- 1 at the bottom

The height of the trigger detectors can be adjusted depending on the number of detectors under test and to optimize the certification speed during the production.

All the 4 RPC gas volumes and 8 read-out panels have been refurbished and the trigger detectors have been assembled and installed at CERN.

Conclusions

New state-of-the-art RPC detectors have been developed:

- New gas volume with 1 mm gas-gap thickness with improved gas and high-voltage distributions:
 - improved time resolution (from 1 ns to 0.4 ns)
 - reduced singlet thickness (13 mm)
- New FE electronics with Si-technology preamplifier and SiGe-HPT ASIC with discriminator and TDC embedded:
 - sensitivity to 1-2 fC
 - TDC time resolution around 100 ps
- Second-coordinate reconstruction capability through difference of signal propagation times along the strip
- Improved rate capability up to 10 kHz/cm²
- New on-detector DCT developed with about 250 ps time resolution

Production of the detector components started:

- Gas-volume production and test in Italy; two additional producers under qualification
- Read-out panel assembly and test at INFN Cosenza and Hefei China
- FE electronics close to complete the integrations tests; ASICs partially produced
- BMBO-DCT second prototype under validation; BI-DCT close to production
- Prototype of the chamber mechanical structure started after tender assignment

Back-up slides

Details of BI-RPCs



Production at CERN



Read-out panels







Standard Layout Sector 13A as an example

BIL and BIS dimensions

		Mechanics				Singlet		Panels		Gas gap		Bakelite		
Factory Name	TC Name	L (sliders included)	Total sliders	hole	w	chamber	L	w	L	W	L	W	L	w
BILA	680	2650	16	0	680	2634	2542	658	2511	658	2466	658	2432	652
BILB	520	2650	16	0	520	2634	2542	498	2511	498	2466	498	2432	492
BILC	680C	2216	16	0	680	2200	2108	658	2077	658	2032	658	1998	652
BILD	520C	2216	16	0	520	2200	2108	498	2077	498	2032	498	1998	492
BILE	680Z	2360	16	0	680	2344	2252	658	2221	658	2176	658	2142	652
BILX	520X	2650	916	900	520	1734	1642	498	1611	498	1566	498	1532	492
BILY	520Y	2650	136	120	520	2514	2422	498	2391	498	2346	498	2312	492
BILYB	520YB	2650	376	360	520	2274	2182	498	2151	498	2106	498	2072	492
BILZ	520CZ	2216	476	460	520	1740	1648	498	1617	498	1572	498	1538	492
V	520S	1440	16	0	520	1424	1332	498	1301	498	1256	498	1222	492
BILW	360S	1518	16	0	360	1502	1410	338	1379	338	1334	338	1300	332
W'	360SS	1840	16	0	360	1824	1732	338	1701	338	1656	338	1622	332

		Mechanics					Singlet		Panels		Gas gap		Bakelite	
Factory Name	TC Name	L (sliders included)	Total sliders	hole	W	chamber	L	w	L	W	L	W	L	
BIS1							1736	1072	1705	1072	1660	1072	1626	1066
BIS2-6							1736	890	1705	890	1660	890	1626	884

õ		Singlet		Panel eta Pan		el phi	Gas Gap		Bakelite		
2		L	w	L	W			L	w	L	w
7	BIS7L	1817	1157	1784	1157	1817	1124	1779	1107	1745	1101
22	BIS7S	1817	967	1784	967	1817	934	1779	917	1745	911
<u>s</u>	BIS8L							1773	367		
B	BIS8S							1653	367		

Length (L) and Width (W) in mm.

Power System

For Phase II, an upgrade of the current Muon Power System is expected. This consists in new modules for LV, HV and ADC for all the Muon detectors. Alongside new power modules, a new Branch Controller is introduced (CAEN R6060) which is responsible for the communication between the DCS and the remote crates. The modules for the BI-RPCs currently have highest priority.



Test-stand trigger logic and performance

A measurement of the trigger time resolution for the cosmic-ray test stand has been performed after the installation of 2 trigger detectors.

The trigger logic has been implemented on an open FPGA module with up to 196 input-output channels interface:

- Quadruple coincidence of 4 read-out planes (2 RPCs with η and ϕ coincidences)

Events

• 40 Regions od Interest (RoIs) defined in the FPGA to perform an online trigger topology and tracking and acquired with a TDC to validate the system.

RPC Trigger 1 4 3 2 10 9 7 11 0.5m **21** η³ 40 31 🗍 ^{ŋ4} → 0.5m RPC Trigger 2 Φ4 Φ3 6 5 2 4 3 1 11 n2 21 🗍 դ: **Trigger logic** 31 n4 40 2.5m

The time of flight is estimated by selecting tracks with hits in each of the 4 panels.

Time resolutions of 2.25 ns and 2.00 ns were measured for ϕ and η panels, respectively.

The rate produced by the FPGA trigger logic is also compared with an equivalent NIM one.

